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April 2013

FDZ8040L Integrated Load Switch

Features

- Optimized for Low-Voltage Core ICs in Portable Systems
- Very Small Package Dimension: WLCSP 0.8 X 0.8 X 0.5 mm³
- Current = 1.2 A, V_{IN} Max. = 4 V
- Current = 2 A, V_{IN} Max. = 4 V (Pulsed)
- $R_{DS(on)} = 80 \text{ m}\Omega \text{ at } V_{ON} = V_{IN} = 4 \text{ V}$
- $R_{DS(on)} = 85 \text{ m}\Omega \text{ at } V_{ON} = V_{IN} = 3.6 \text{ V}$
- $R_{DS(on)} = 90 \text{ m}\Omega \text{ at } V_{ON} = V_{IN} = 3 \text{ V}$
- $R_{DS(on)} = 360 \text{ m}\Omega \text{ at } V_{ON} = V_{IN} = 0.9 \text{ V}$
- $R_{DS(on)} = 1000 \text{ m}\Omega$ at $V_{ON} = V_{IN} = 0.8 \text{ V}$





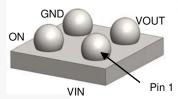


Figure 1. Bottom View

Description

This device is particularly suited for compact power management in portable applications needing 0.8 V to 4 V input and 1.2 A output current capability. This load switch integrated a level-shifting function that drives a P-channel power MOSFET in a very small 0.8 X 0.8 X 0.5 mm³ WLCSP package.

Applications

- Load Switch
- Power Management in Portable Applications



Figure 2. Top View

Ordering Information

Part Number	Device Mark	Ball Pitch	Operating Temperature Range	Switch	Package	Packing Method
FDZ8040L	ZM	0.4 mm	-40 to 85°C	80 mΩ, P-Channel MOSFET	0.8 x 0.8 x 0.5 mm ³ WLCSP	Tape & Reel

Typical Application

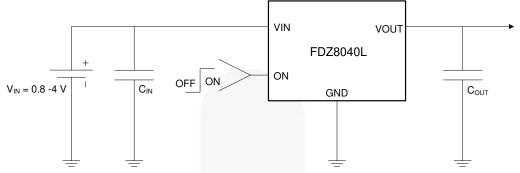


Figure 3. Typical Application

Block Diagram

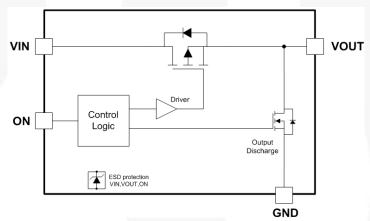


Figure 4. Internal Block Diagram

Pin Configuration

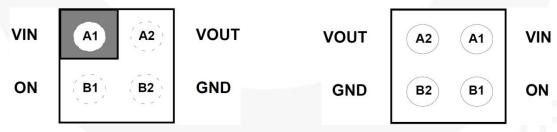


Figure 5. Top View (Bumps Down) Figure 6. Bottom View (Bumps Up)

Pin Descriptions

Pin#	Name	Description	
A1	VIN	Supply Input: Input to the load switch	
A2	VOUT	witch Output: Output of the load switch	
B1	ON	N/OFF Control Input	
B2	GND	Ground	

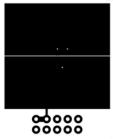
Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

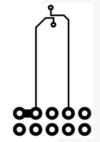
Symbol	Parameter			Max.	Unit
V _{IN}	Voltage on VIN, VOUT, ON to GNE		-0.3	4.2	V
I _{OUT_C}	I _{OUT} -Load Current (Continuous) ^(1a)			1.2	Α
I _{OUT_P}	I _{OUT} -Load Current (Pulsed)			2	Α
P _D	Power Dissipation at $T_A = 25^{\circ}C^{(1a)}$			0.9	W
T _A	Operating Temperature Range		-40	85	°C
T _{STG}	Storage Temperature			150	°C
$R_{\Theta_{JA}}$	Thermal Resistance, Junction to Ar	mbient ^(1a)		135	°C/W
ESD	Flacturatatia Disabawa Conshilitu	Human Body Model, JESD22-A114	8		kV
ESD	Electrostatic Discharge Capability	Charged Device Model, JESD22-C101	2		N.V

Notes:

RO_{JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal
reference is defined as the solder mounting surface of the drain pins. RO_{JC} is guaranteed by design, while RO_{JA}
is determined by the board design.



a. 135°C/W when mounted on a 1-inch square pad of 2-oz copper.



b. 360°C/W when mounted on a minimum pad of 2-oz copper.

2. Pulse test: pulse width $< 300 \mu s$; duty cycle < 2.0%.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Pa	Min.	Max.	Unit	
V _{IN}	Voltage on VIN Pin	0.8	4.0	V	
V _{ON}	Voltage on ON Pin		0.7	4.0	V
т	Operating Temperature	1 V to 4 V	-40	0E	°C
T _A	Range	0.8 V to 4 V	-10	85	

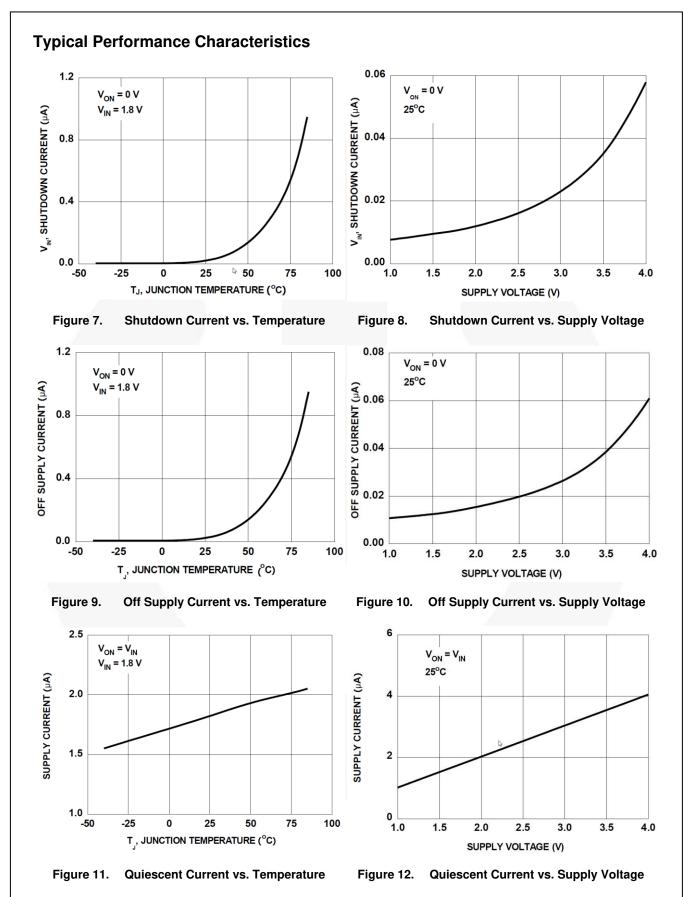
Electrical Characteristics

 $T_{J}=25^{\circ}C$ and $V_{IN}{=}1.8~V,$ unless otherwise noted.

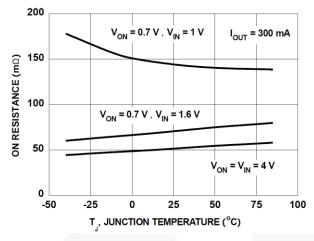
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
V _{IN}	Operation Voltage		0.8		4.0	٧	
\/	ON legat Legis Legy Velters	$1.6 \text{ V} \le \text{V}_{\text{IN}} \le 4.0 \text{ V}$			0.35	V	
V_{IL}	ON Input Logic Low Voltage	$0.8 \text{ V} \le \text{V}_{\text{IN}} \le 1.6 \text{ V}$			0.25	V	
W	ON Input Logic High Voltage	$1.6 \text{ V} \le \text{V}_{\text{IN}} \le 4.0 \text{ V}$	1.0			W	
V_{IH}	ON Input Logic High Voltage	$0.8 \text{ V} \le \text{V}_{\text{IN}} \le 1.6 \text{ V}$	0.7			V	
ΙQ	Quiescent Current	$I_{OUT} = 0 \text{ mA}, V_{IN} = V_{ON} = 1.8 \text{ V}$			2.1	μΑ	
$I_{Q(off)}$	Off Supply Current	$I_{OUT} = 0$ mA, $V_{IN} = 1.8$ V, $V_{ON} = GND$			1	μA	
I _{SD(off)}	Off Switch Current	$V_{ON} = GND$, $V_{OUT} = 0$ V, $V_{IN} = 1.8$ V			100	nA	
I_{ON}	ON Input Leakage	$V_{ON} = V_{IN}$ or GND			1	μA	
R_{PD}	Output Discharge Pull-Down Resistance			200		Ω	
- 2		$V_{ON} = V_{IN} = 4 \text{ V}, I_{OUT} = 300 \text{ mA}$		50	80		
		$V_{ON} = V_{IN} = 3.6 \text{ V}, I_{OUT} = 300 \text{ mA}$		51	85		
		$V_{ON} = V_{IN} = 3 \text{ V}, I_{OUT} = 300 \text{ mA}$		54	90		
		$V_{ON} = 0.7 \text{ V}, V_{IN} = 1.6 \text{ V}, I_{OUT} = 300 \text{ mA}$		73	110		
		$V_{ON} = 0.7 \text{ V}, V_{IN} = 1 \text{ V}, I_{OUT} = 300 \text{ mA}$		140	309		
R _{DS(ON)}	Static Drain-Source	$V_{ON} = V_{IN} = 0.9 \text{ V}, I_{OUT} = 10 \text{ mA}$		186	360	mΩ	
25(5.1)	On-Resistance	$V_{ON} = V_{IN} = 0.8 \text{ V}, I_{OUT} = 10 \text{ mA}$		348	1000		
		$\begin{split} V_{ON} &= V_{IN} = 0.9 \text{ V, } I_{OUT} = 10 \text{ mA,} \\ T_J &= 10 \sim 85^{\circ}C \end{split}$		194	370		
		$V_{ON} = V_{IN} = 0.8 \text{ V}, \ I_{OUT} = 10 \text{ mA}, \ T_J = 10 \sim 85^{\circ}\text{C}$		268	750		
		$V_{IN} = 3.6 \text{ V}, I_{OUT} = 300 \text{ mA}, T_J = 85^{\circ}\text{C}$		59	102		

Switching Characteristics

Symbol	Parameter	Test Conditions	Typical	Unit
^t d(on)	Turn-On Delay Time		22	μs
t _r	Turn-On Rise Time	V 40VV 07V 0 4 15 D 500 0	23	μs
td(off)	Turn-Off Delay Time	$V_{IN} = 1.6 \text{ V}, V_{ON} = 0.7 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	109	μs
tf	Turn-Off Fall Time		285	μs
^t d(on)	Turn-On Delay Time		37	μs
t _r	Turn-On Rise Time	V 1VV 10V C 1::F B 500 C	35	μs
td(off)	Turn-Off Delay Time	$V_{IN} = 1 \text{ V}, V_{ON} = 1.8 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	112	μs
t _f	Turn-Off Fall Time		332	μs
^t d(on)	Turn-On Delay Time		20	μs
t _r	Turn-On Rise Time	V 10VV 10V 0 1 5 5 5000	22	μs
td(off)	Turn-Off Delay Time	$V_{IN} = 1.8 \text{ V}, V_{ON} = 1.8 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	122	μs
tf	Turn-Off Fall Time		296	μs
^t d(on)	Turn-On Delay Time		15	μs
t _r	Turn-On Rise Time], 05,4,4, 10,4,0, 1,5,0,500,0	19	μs
td(off)	Turn-Off Delay Time	$V_{IN} = 2.5 \text{ V}, V_{ON} = 1.8 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	160	μs
t _f	Turn-Off Fall Time		295	μs
^t d(on)	Turn-On Delay Time		13	μs
t _r	Turn-On Rise Time	V 00VV 10V 0 1 5 D 5000	18	μs
td(off)	Turn-Off Delay Time	$V_{IN} = 3.3 \text{ V}, V_{ON} = 1.8 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	193	μs
t _f	Turn-Off Fall Time		305	μs
^t d(on)	Turn-On Delay Time		53	μs
t _r	Turn-On Rise Time	V 00VV 00V 0 4 5 D 5000	56	μs
td(off)	Turn-Off Delay Time	$V_{IN} = 0.8 \text{ V}, V_{ON} = 0.8 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	143	μs
tf	Turn-Off Fall Time		532	μs
^t d(on)	Turn-On Delay Time		51	μs
t _r	Turn-On Rise Time	V 00VV 00V 0 1 5 5	54	μs
^t d(off)	Turn-Off Delay Time	$V_{IN} = 0.9 \text{ V}, V_{ON} = 0.9 \text{ V}, C_L = 1 \mu\text{F}, R_L = 500 \Omega$	148	μs
t _f	Turn-Off Fall Time		525	μs



Typical Performance Characteristics



200 $V_{ON} = V_{IN}$ I_{OUT} = 300 mA 150 ON RESISTANCE (MD) 100 85°C 50 -40°C 25°C 0 1.0 1.5 2.0 2.5 3.0 3.5 4.0 SUPPLY VOLTAGE (V)

Figure 13. Ron vs. Temperature

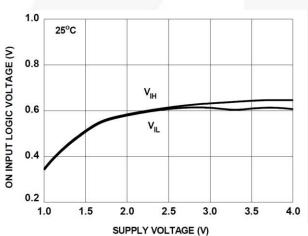


Figure 14. Ron vs. Supply Voltage

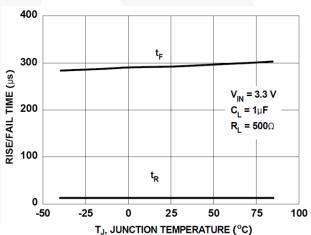


Figure 15. ON-Pin Threshold vs. VIN

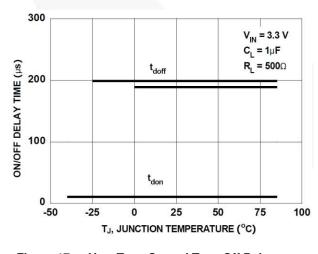


Figure 16. V_{OUT} Rise and Fall Time vs. Temperature at R_L =500 Ω

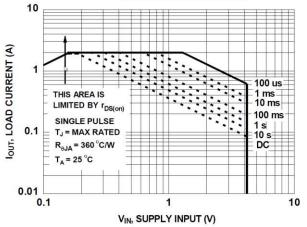


Figure 17. V_{OUT} Turn-On and Turn-Off Delay vs. Temperature at R_L =500 Ω

Figure 18. Forward Bias Safe Operation Area



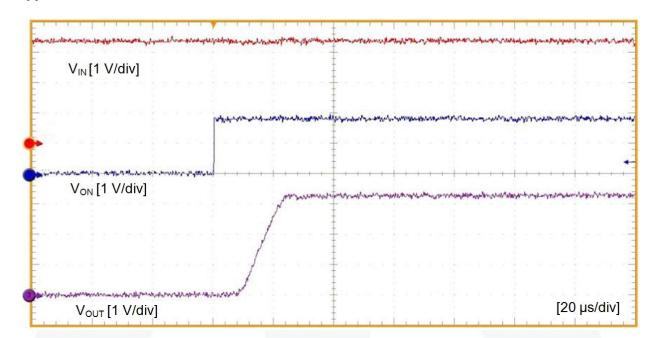


Figure 19. Turn-On Response (V_{IN} = 3.3 V, C_{OUT} =1 μ F, R_L =500 Ω)

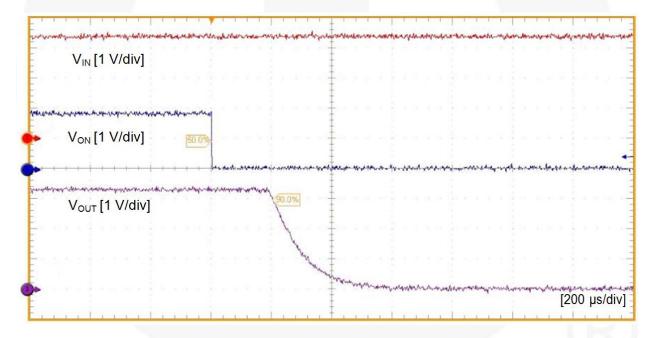


Figure 20. Turn-Off Response (V_{IN} = 3.3 V, C_{OUT}=1 μ F, R_L=500 Ω)

Functional Description

The FDZ8040L is a low- $R_{DS(ON)}$ P-channel load switch packaged in space-saving 0.8 x 0.8 WLCSP.

The core of the device is an 80 m Ω P-channel MOSFET capable of functioning over a wide input operating range

of 0.8-4 V. The ON pin, an active HIGH TTL-compatible input that supports input as low as $0.7~\rm{V}$, controls the state of the switch.

Applications Information

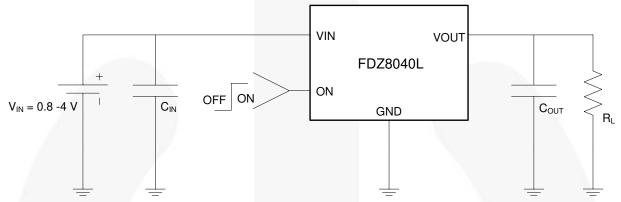


Figure 21. Typical Application

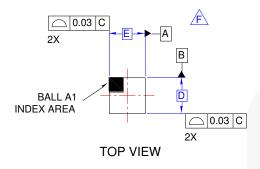
Input Capacitor

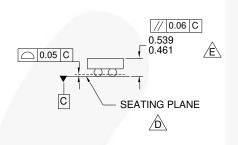
To reduce device inrush current effect, a 0.1 μ F ceramic capacitor, C_{IN} , is recommended close to the VIN pin. A higher value of C_{IN} can be used to further reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

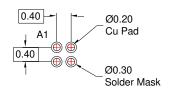
Output Capacitor

FDZ8040L works without an output capacitor. However, if parasitic board inductance forces V_{OUT} below GND when switching off, a 0.1 μF capacitor, C_{OUT} , should be placed between the VOUT and GND pins.

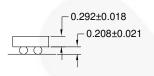
Physical Dimensions







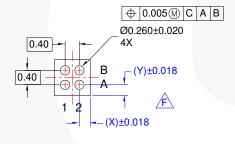
RECOMMENDED LAND PATTERN (NSMD PAD TYPE)



SIDE VIEWS

NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASME Y14.5M, 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E PACKAGE NOMINAL HEIGHT IS 500 MICRONS ±39 MICRONS (461-539 MICRONS).
- FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC004AFrev1.



BOTTOM VIEW

Figure 22. 4-Ball, WLCSP, 2 X 2 Array, 0.4 mm Pitch, 250 µm Ball

Product-Specific Dimensions

Product	D	E	X	Υ
FDZ8040L	0.8 ±0.03 mm	0.8 ±0.03 mm	0.21 mm	0.21 mm

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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